

### ABSTRACT

The invention relates to an electrical device having an electronic circuit disposed at least in part on a printed circuit board (3); the circuit has power components (4), each with an arrangement for heat dissipation. A housing frame (1) for the electronic circuit is present, and the housing frame (1) has a number of ribs (6, 7), which are joined to the respective housing frame wall but are offset and on which the heat-carrying housing parts of the power components (4) are kept in thermal contact, and the housing frame (1) can be joined to a heat-dissipating housing bottom (2) by thermal contact.

(Sole drawing figure)